48 Ŋ 1LE

DGG, DGV, OR DL PACKAGE

(TOP VIEW)

1OF

1Q1

V_{CC} L

2Q6 []20 GND [] 21

2Q7 [122

2Q8 ¶23

20E [

18 2Q5 🛮 19

24

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47 🛮 1D1

31 🛮 V_{CC}

30 D 2D5

29 D2D6

28 GND

27 🛮 2D7

26 🛮 2D8

25 2LE

- **Member of the Texas Instruments** Widebus™ Family
- Typical V_{OLP} (Output Ground Bounce) <0.8 V at $V_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$
- Typical V_{OHV} (Output V_{OH} Undershoot)

- 2000-V Human-Body Model (A114-A)
- 200-V Machine Model (A115-A)

description/ordering information

This 16-bit transparent D-type latch is designed for 1.65-V to 3.6-V V_{CC} operation.

The SN74LVCH16373A is particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers. It

can be used as two 8-bit latches or one 16-bit latch. When the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs. When LE is taken low, the Q outputs are latched at the levels set up at the D inputs.

A buffered output-enable (OE) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

1Q2 []3 46 1 1D2 >2 V at V_{CC} = 3.3 V, T_A = 25°C 45 GND GND 4 **I**off Supports Partial-Power-Down Mode 1Q3 **∏**5 44 **∏** 1D3 Operation 1Q4 **∏**6 43 🛮 1D4 42 🛮 V_{CC} V_{CC} **□**7 **Supports Mixed-Mode Signal Operation** 1Q5 🛮 8 41 🛮 1D5 (5-V Input and Output Voltages With 1Q6 🛮 9 40 🛮 1D6 3.3-V V_{CC}) GND 10 39 D GND Bus Hold on Data Inputs Eliminates the 38 🛮 1D7 11 1Q7 🛮 **Need for External Pullup/Pulldown** 37 1D8 1Q8 🛮 12 Resistors 2Q1 113 36 T 2D1 Latch-Up Performance Exceeds 250 mA Per 14 35 D2 2Q2 [**JESD 17** 15 34 🛛 GND GND [**ESD Protection Exceeds JESD 22** 33 D 2D3 2Q3 [17 32 D2D4 2Q4 []

ORDERING INFORMATION

TA	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	0000 01	Tube	SN74LVCH16373ADL	11/01/400704
	SSOP – DL	Tape and reel	SN74LVCH16373ADLR	LVCH16373A
4000 to 0500	TSSOP - DGG	Tape and reel	SN74LVCH16373ADGGR	LVCH16373A
-40°C to 85°C	TVSOP – DGV	Tape and reel	SN74LVCH16373ADGVR	LDH373A
	VFBGA – GQL	Tana and saal	SN74LVCH16373AGQLR	I DU 1070 A
	VFBGA – ZQL (Pb-free)	Tape and reel	SN74LVCH16373AZQLR	LDH373A

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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Widebus is a trademark of Texas Instruments

SN74LVCH16373A 16-BIT TRANSPARENT D-TYPE LATCH WITH 3-STATE OUTPUTS

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description/ordering information (continued)

OE does not affect internal operations of the latch. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

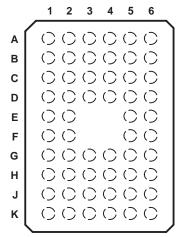
Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of this device as a translator in a mixed 3.3-V/5-V system environment.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial-power-down applications using Ioff. The Ioff circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

GQL OR ZQL PACKAGE (TOP VIEW)



terminal assignments

	1	2	3	4	5	6
Α	1OE	NC	NC	NC	NC	1LE
В	1Q2	1Q1	GND	GND	1D1	1D2
С	1Q4	1Q3	Vcc	Vcc	1D3	1D4
D	1Q6	1Q5	GND	GND	1D5	1D6
Ε	1Q8	1Q7			1D7	1D8
F	2Q1	2Q2			2D2	2D1
G	2Q3	2Q4	GND	GND	2D4	2D3
Н	2Q5	2Q6	Vcc	Vcc	2D6	2D5
J	2Q7	2Q8	GND	GND	2D8	2D7
K	2OE	NC	NC	NC	NC	2LE

NC - No internal connection

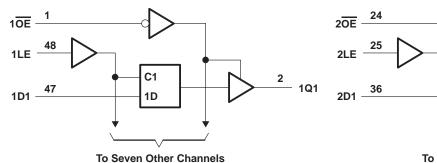
FUNCTION TABLE

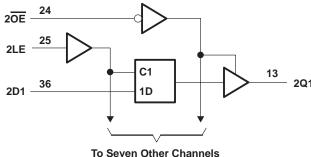
	INPUTS		OUTPUT
OE	LE	D	Q
L	Н	Н	Н
L	Н	L	L
L	L	Χ	Q_0
Н	Χ	Χ	Z



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logic diagram (positive logic)





Pin numbers shown are for the DGG, DGV, and DL packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V _{CC}		
Voltage range applied to any output in the high-i		
(see Note 1)		–0.5 V to 6.5 V
Voltage range applied to any output in the high of	or low state, V _O	
(see Notes 1 and 2)		$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, I_{IK} ($V_I < 0$)		–50 mA
Output clamp current, I _{OK} (V _O < 0)		
Continuous output current, I _O		±50 mA
Continuous current through each V _{CC} or GND		±100 mA
Package thermal impedance, θ_{JA} (see Note 3):	DGG package	70°C/W
	DGV package	58°C/W
	DL package	
	GQL/ZQL package	
Storage temperature range, T _{stq}		–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. The value of V_{CC} is provided in the recommended operating conditions table.
- 3. The package thermal impedance is calculated in accordance with JESD 51-7.



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recommended operating conditions (see Note 4)

			MIN	MAX	UNIT
.,	Complementers	Operating	1.65	3.6	V
VCC	Supply voltage	Data retention only	1.5		V
		V _{CC} = 1.65 V to 1.95 V	0.65 × V _{CC}		
V_{IH}	High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2		
		V _{CC} = 1.65 V to 1.95 V		$0.35 \times V_{CC}$	
V_{IL}	Low-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.7	V
		V _{CC} = 2.7 V to 3.6 V		0.8	
٧ı	Input voltage	·	0	5.5	V
.,	V _O Output voltage	High or low state	0	VCC	
VO		3-state	0	5.5	V
		V _{CC} = 1.65 V		-4	
		V _{CC} = 2.3 V		-8	
ЮН	High-level output current	V _{CC} = 2.7 V		-12	mA
		V _{CC} = 3 V		-24	
		V _{CC} = 1.65 V		4	
		V _{CC} = 2.3 V		8	
lOL	Low-level output current	V _{CC} = 2.7 V		12	mA
		VCC = 3 V		24	
Δt/Δν	Input transition rise or fall rate	•		10	ns/V
TA	Operating free-air temperature		-40	85	°C

NOTE 4: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	v _{cc}	MIN	TYP† MAX	UNIT
	I _{OH} = -100 μA	1.65 V to 3.6 V	V _{CC} -0.2		
	$I_{OH} = -4 \text{ mA}$	1.65 V	1.2]
V	$I_{OH} = -8 \text{ mA}$	2.3 V	1.7		V
VOH	la = 12 mA	2.7 V	2.2		V
	I _{OH} = -12 mA	3 V	2.4		
	$I_{OH} = -24 \text{ mA}$	3 V	2.2		
	$I_{OL} = 100 \mu\text{A}$	1.65 V to 3.6 V		0.2]
	$I_{OL} = 4 \text{ mA}$	1.65 V		0.45]
VOL	$I_{OL} = 8 \text{ mA}$	2.3 V		0.7	V
	$I_{OL} = 12 \text{ mA}$	2.7 V		0.4]
	I _{OL} = 24 mA	3 V		0.55	
lį	V _I = 0 to 5.5 V	3.6 V		±5	μΑ
	V _I = 0.58 V	1.65 V	‡]
	V _I = 1.07 V	1.05 V	‡]
	V _I = 0.7 V	2.3 V	45]
l _l (hold)	V _I = 1.7 V	2.5 V	-45		μΑ
	V _I = 0.8 V	3 V	75]
	V _I = 2 V	3 V	-75		
	V _I = 0 to 3.6 V§	3.6 V		±500	
l _{off}	V_I or $V_O = 5.5 V$	0		±10	μΑ
loz	$V_{O} = 0 \text{ to } 5.5 \text{ V}$	3.6 V		±10	μΑ
	$V_I = V_{CC}$ or GND	0.01/		20	
Icc	$3.6 \text{ V} \le \text{V}_{\text{I}} \le 5.5 \text{ V}^{\text{I}}$ $I_{\text{O}} = 0$	3.6 V		20	μΑ
Δl _{CC}	One input at V_{CC} – 0.6 V, Other inputs at V_{CC} or GND	2.7 V to 3.6 V		500	μΑ
Ci	$V_I = V_{CC}$ or GND	3.3 V		5	pF
Co	$V_O = V_{CC}$ or GND	3.3 V		6.5	pF

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

		V _{CC} = 1.8 V ± 0.15 V				V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t _W	Pulse duration, LE high	‡		‡		3.3		3.3		ns
t _{su}	Setup time, data before LE \downarrow	‡		‡		1.7		1.7		ns
th	Hold time, data after LE↓	‡		‡		1.2		1.2		ns

[‡] This information was not available at the time of publication.



[†] All typical values are at V_{CC} = 3.3 V, T_A = 25°C. ‡ This information was not available at the time of publication.

[§] This is the bus-hold maximum dynamic current required to switch the input from one state to another.

[¶] This applies in the disabled state only.

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switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	TO (OUTPUT)	V _{CC} = ± 0.1		V _{CC} =	2.5 V 2 V	V _{CC} =	2.7 V	V _{CC} =	3.3 V 3 V	UNIT
	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
	D	_	†	†	†	†		4.9	1.6	4.2	
^t pd	LE	Q	†	†	†	†		5.3	2.1	4.6	ns
t _{en}	ŌĒ	Q	†	†	†	†		5.7	1.3	4.7	ns
t _{dis}	ŌĒ	Q	†	†	†	†		6.3	2.5	5.9	ns

[†] This information was not available at the time of publication.

operating characteristics, $T_A = 25^{\circ}C$

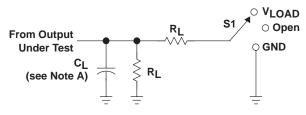
	PARAMETER	TEST	V _{CC} = 1.8 V	V _{CC} = 2.5 V	V _{CC} = 3.3 V	UNIT	
PARAMETER		CONDITIONS	TYP	TYP	TYP	UNIT	
<u> </u>	Power dissipation capacitance	Outputs enabled		†	†	39	1
Cpd	per latch	Outputs disabled	f = 10 MHz	†	†	6	pF

[†] This information was not available at the time of publication.



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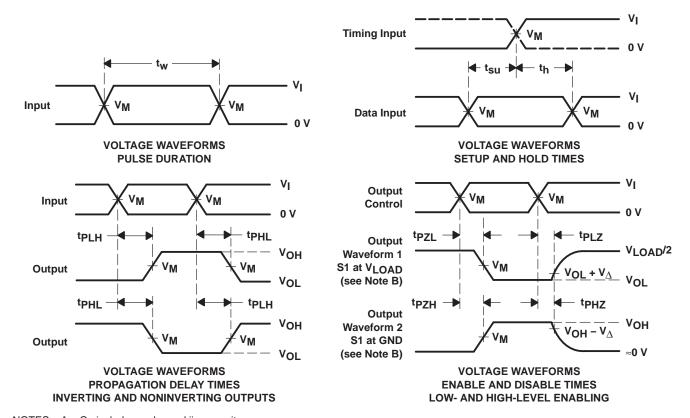
PARAMETER MEASUREMENT INFORMATION



TEST	S1
tPLH/tPHL	Open
tPLZ/tPZL	VLOAD
tPHZ/tPZH	GND

LOAD CIRCUIT

W	IN	PUT	V	V	0.	D.	V
Vcc	٧ _I	t _r /t _f	VΜ	VLOAD	CL	RL	$v_{\scriptscriptstyle\Delta}$
1.8 V ± 0.15 V	VCC	≤2 ns	V _{CC} /2	VCC	30 pF	1 k Ω	0.15 V
2.5 V \pm 0.2 V	VCC	≤2 ns	V _{CC} /2	VCC	30 pF	500 Ω	0.15 V
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
3.3 V \pm 0.3 V	2.7 V	≤ 2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V



NOTES: A. C_L includes probe and jig capacitance.

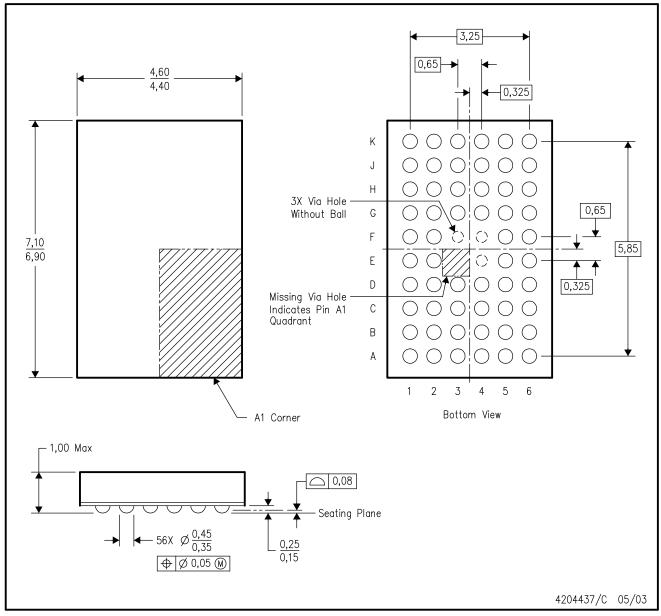
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



ZQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. MicroStar Junior™ BGA configuration.
- D. Falls within JEDEC MO-225 variation BA.
- E. This package is lead-free. Refer to the 56 GQL package (drawing 4200583) for tin-lead (SnPb).

MicroStar Junior is a trademark of Texas Instruments.



DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

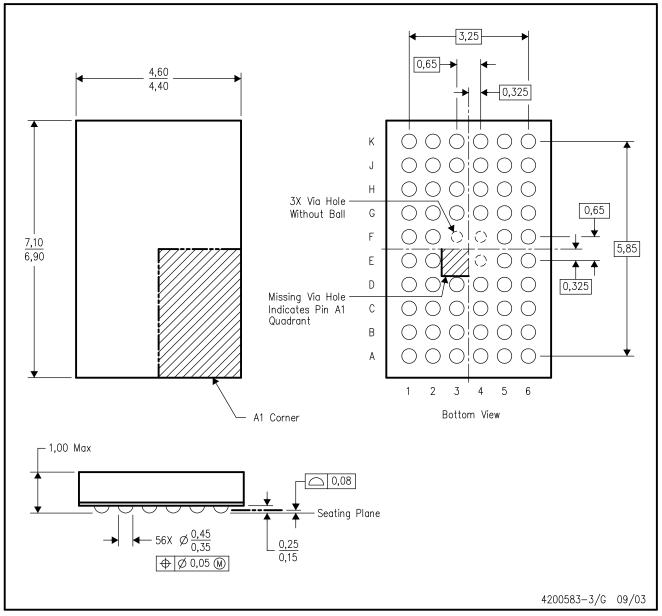
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194



GQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. MicroStar Junior™ BGA configuration.
- D. Falls within JEDEC MO-225 variation BA.
- E. This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.

MicroStar Junior is a trademark of Texas Instruments.



DL (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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